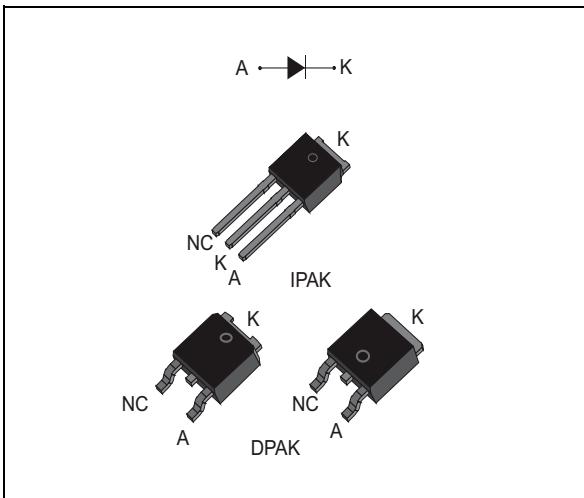


High voltage power Schottky rectifier

Datasheet - production data



Description

This high voltage Schottky barrier rectifier is packaged in DPAK and IPAK and designed for high frequency compact switched mode power supply such as adaptors and on board DC-DC converters.

Table 1. Device summary

| Symbol | Value |
|-------------------|--------|
| $I_{F(AV)}$ | 5 A |
| V_{RRM} | 100 V |
| T_j | 175 °C |
| $V_F(\text{max})$ | 0.61 V |

Features

- Negligible switching losses
- High junction temperature capability
- Low leakage current
- Good trade off between leakage current and forward voltage drop
- Avalanche capability specified
- ECOPACK®2 compliant component for IPAK and DPAK on demand

1 Characteristics

Table 2. Absolute ratings (limiting values)

| Symbol | Parameter | | Value | Unit | |
|-------------|---|--|--|------------------|---|
| V_{RRM} | Repetitive peak reverse voltage | | 100 | V | |
| $I_F(RMS)$ | RMS forward voltage | | 10 | A | |
| $I_{F(AV)}$ | Average forward current, $\bar{\delta} = 0.5$ | | $T_C = 165 \text{ }^\circ\text{C}$ | 5 | A |
| I_{FSM} | Surge non repetitive forward current | | $t_p = 10 \text{ ms sinusoidal}$ | 75 | A |
| P_{ARM} | Repetitive peak avalanche power | | $t_p = 10 \mu\text{s}, T_j = 125 \text{ }^\circ\text{C}$ | 515 | W |
| T_{stg} | Storage temperature range | | -65 to + 175 | $^\circ\text{C}$ | |
| T_j | Maximum operating junction temperature ⁽¹⁾ | | 175 | $^\circ\text{C}$ | |

1. $\frac{dP_{tot}}{dT_j} < \frac{1}{R_{th(j-a)}}$ condition to avoid thermal runaway for a diode on its own heatsink

Table 3. Thermal resistance

| Symbol | Parameter | Value | Unit |
|---------------|------------------|-------|--------------------|
| $R_{th(j-c)}$ | Junction to case | 2.5 | $^\circ\text{C/W}$ |

Table 4. Static electrical characteristics

| Symbol | Parameter | Tests conditions | | Min. | Typ | Max. | Unit |
|----------------------|-------------------------|------------------------------------|----------------------|------|------|------|---------------|
| I_R ⁽¹⁾ | Reverse leakage current | $T_j = 25 \text{ }^\circ\text{C}$ | $V_R = V_{RRM}$ | | | 3.5 | μA |
| | | $T_j = 125 \text{ }^\circ\text{C}$ | | | 1.3 | 4.5 | mA |
| V_F ⁽²⁾ | Forward voltage drop | $T_j = 25 \text{ }^\circ\text{C}$ | $I_F = 5 \text{ A}$ | | | 0.73 | V |
| | | $T_j = 125 \text{ }^\circ\text{C}$ | | | 0.57 | 0.61 | |
| | | $T_j = 25 \text{ }^\circ\text{C}$ | $I_F = 10 \text{ A}$ | | | 0.85 | |
| | | $T_j = 125 \text{ }^\circ\text{C}$ | | | 0.66 | 0.71 | |

1. $t_p = 5 \text{ ms}, \delta < 2\%$

2. $t_p = 380 \mu\text{s}, \delta < 2\%$

To evaluate the conduction losses use the following equation:

$$P = 0.51 \times I_{F(AV)} + 0.02 I_F^2(RMS)$$

Figure 1. Average forward power dissipation versus average forward current

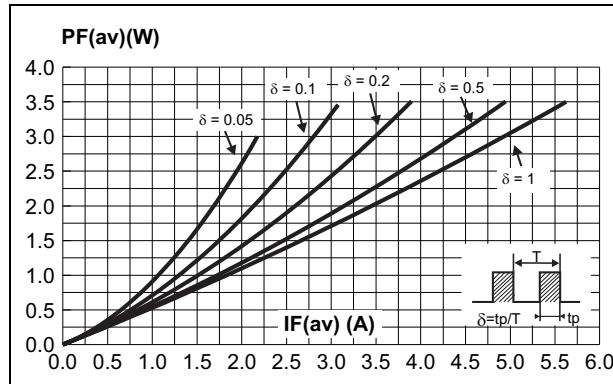


Figure 2. Average forward current versus ambient temperature, $\delta = 0.5$

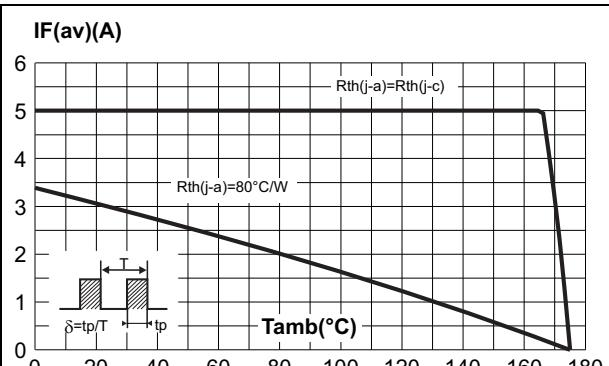


Figure 3. Normalized avalanche power derating versus pulse duration at $T_j = 125^\circ C$

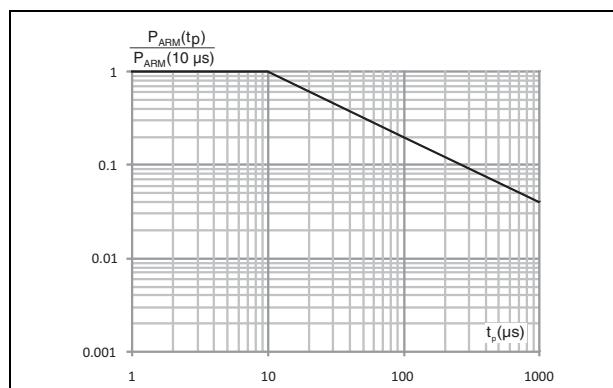


Figure 4. Non repetitive surge peak forward current versus overload duration (maximum values)

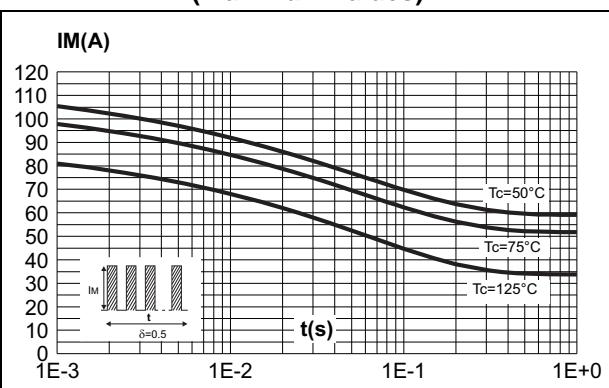


Figure 5. Relative variation of thermal impedance junction to case versus pulse duration

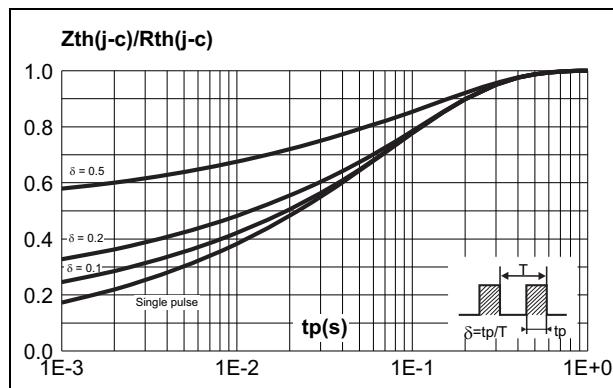


Figure 6. Reverse leakage current versus reverse voltage applied (typical values)

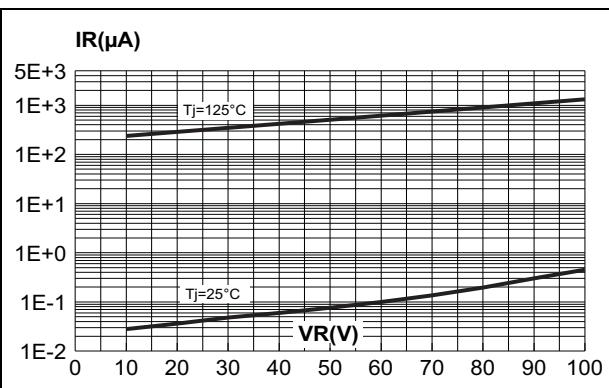


Figure 7. Junction capacitance versus reverse voltage applied (typical values)

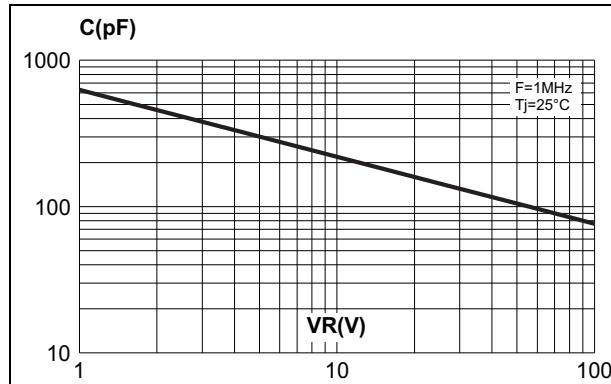


Figure 8. Forward voltage drop versus forward current (maximum values)

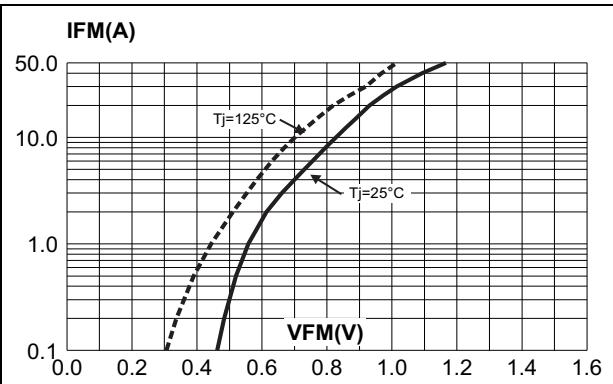
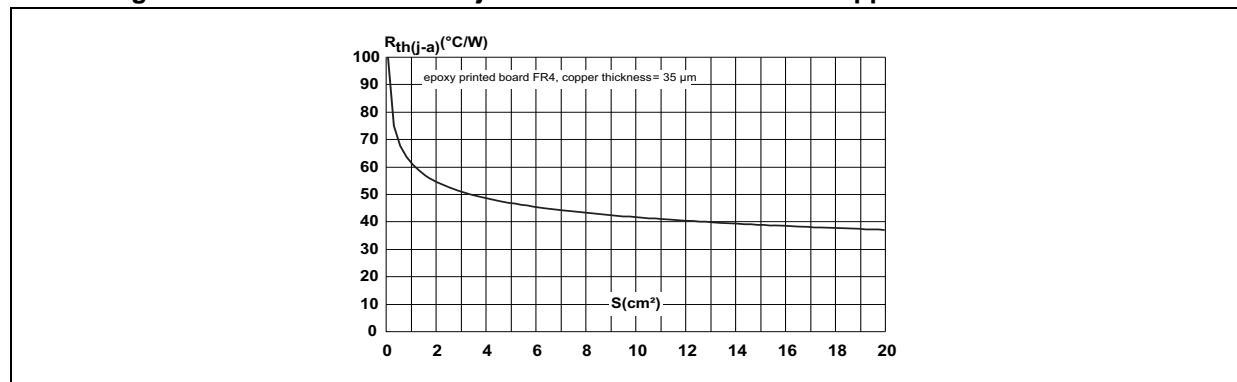


Figure 9. Thermal resistance junction to ambient versus copper surface under tab

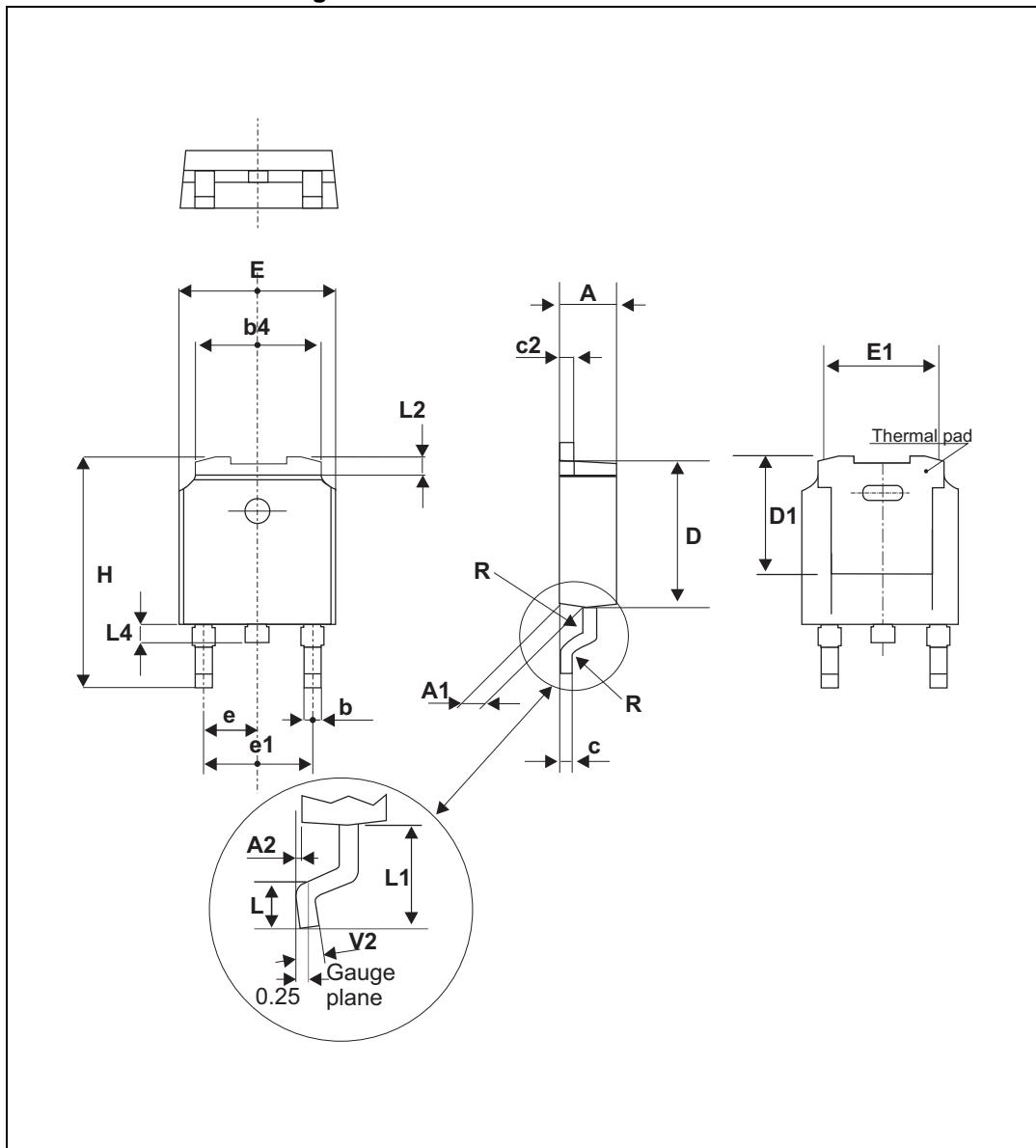


2 Package Information

- Epoxy meets UL94,V0
- Cooling method: by conduction (C)

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: www.st.com.
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Figure 10. DPAK dimension definitions



Note:

This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 5. DPAK dimension values

| Ref. | Dimensions | | | | | |
|------|-------------|------|-------|--------|------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 2.18 | | 2.40 | 0.085 | | 0.094 |
| A1 | 0.90 | | 1.1 | 0.035 | | 0.043 |
| A2 | 0.03 | | 0.23 | 0.001 | | 0.01 |
| b | 0.64 | | 0.90 | 0.025 | | 0.035 |
| b4 | 4.95 | | 5.46 | 0.195 | | 0.215 |
| c | 0.46 | | 0.61 | 0.018 | | 0.024 |
| c2 | 0.46 | | 0.60 | 0.018 | | 0.024 |
| D | 5.97 | | 6.22 | 0.235 | | 0.245 |
| D1 | 5.10 | | | 0.201 | | |
| E | 6.35 | | 6.73 | 0.250 | | 0.265 |
| E1 | 4.32 | | | 0.170 | | |
| e1 | 4.4 | | 4.7 | 0.173 | | 0.185 |
| H | 9.35 | | 10.40 | 0.368 | | 0.407 |
| L | 1.0 | | 1.78 | 0.039 | | 0.070 |
| L2 | | | 1.27 | | | 0.05 |
| L4 | 0.6 | | 1.02 | 0.024 | | 0.040 |
| V2 | 0° | | 8° | 0° | | 8° |

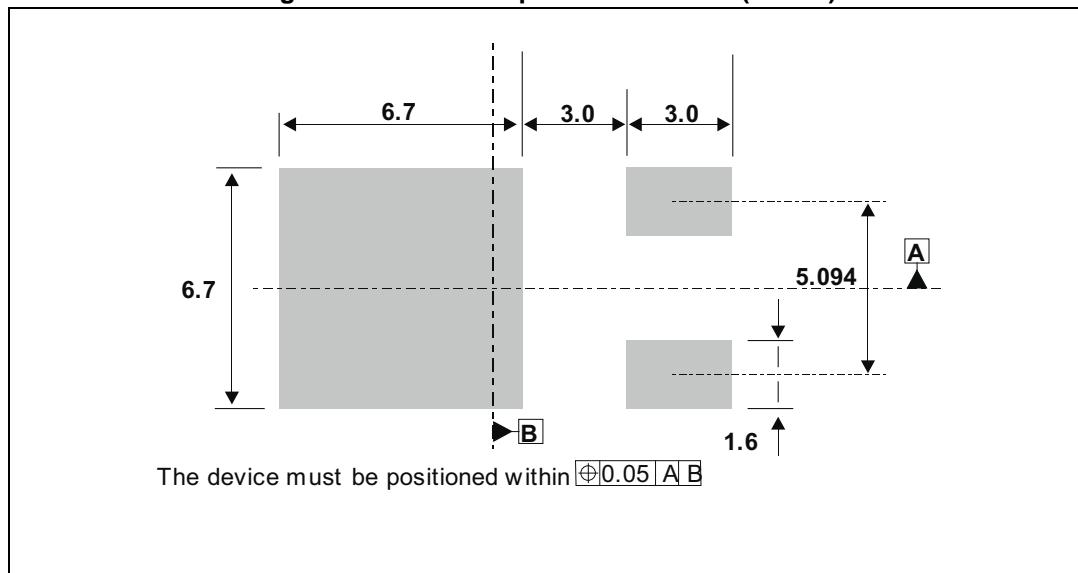
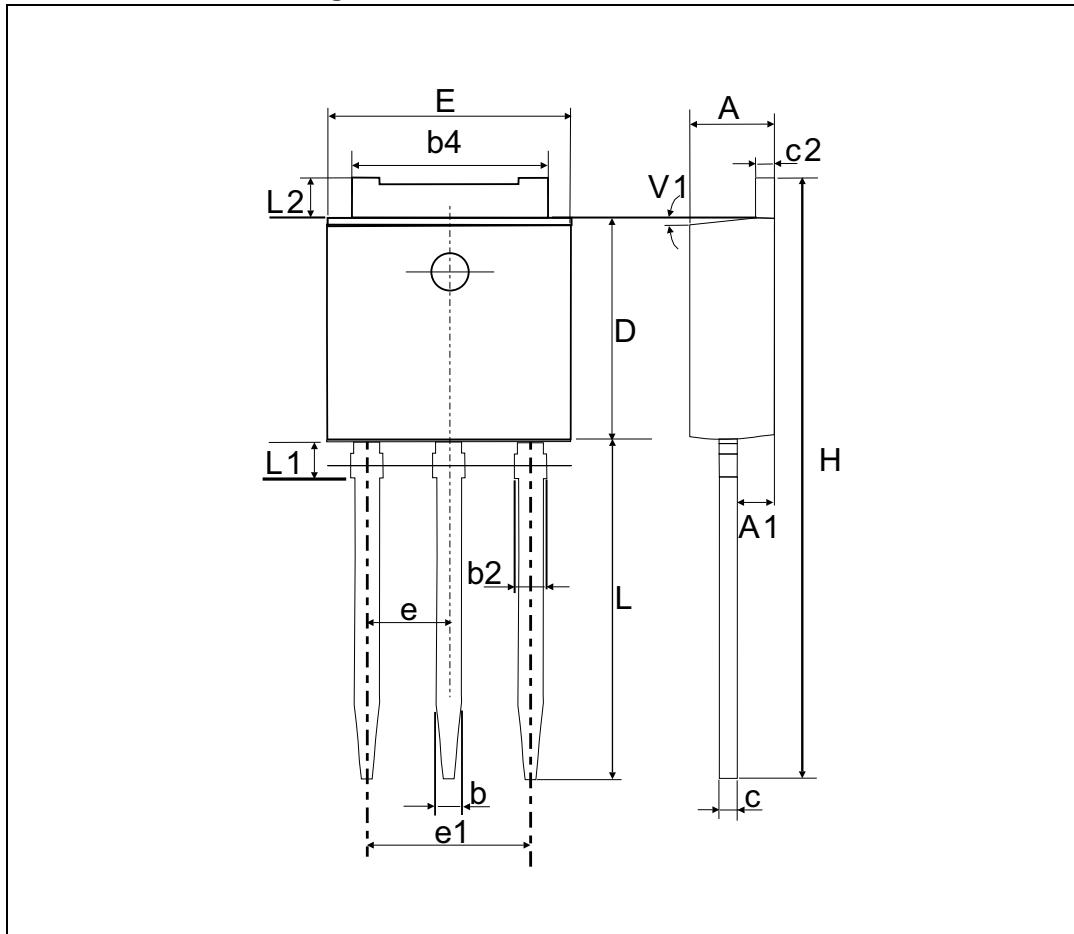
Figure 11. DPAK footprint dimensions (in mm)

Figure 12. IPAK dimension definitions



Note: This package drawing may slightly differ from the physical package. However, all the specified dimensions are guaranteed.

Table 6. IPAK dimension values

| Ref. | Dimensions | | | | | |
|------|-------------|-------|------|--------|-------|-------|
| | Millimeters | | | Inches | | |
| | Min. | Typ. | Max. | Min. | Typ. | Max. |
| A | 2.20 | | 2.40 | 0.086 | | 0.094 |
| A1 | 0.90 | | 1.10 | 0.035 | | 0.043 |
| A3 | 0.70 | | 1.30 | 0.027 | | 0.051 |
| B | 0.64 | | 0.90 | 0.025 | | 0.035 |
| B2 | 5.20 | | 5.40 | 0.204 | | 0.212 |
| B3 | | | 0.95 | | | 0.037 |
| B5 | | 0.30 | | | 0.035 | |
| C | 0.45 | | 0.60 | 0.017 | | 0.023 |
| C2 | 0.48 | | 0.60 | 0.019 | | 0.023 |
| D | 6 | | 6.20 | 0.236 | | 0.244 |
| E | 6.40 | | 6.65 | 0.252 | | 0.262 |
| e | | 2.28 | | | 0.090 | |
| G | 4.40 | | 4.60 | 0.173 | | 0.181 |
| H | | 16.10 | | | 0.634 | |
| L | 9 | | 9.40 | 0.354 | | 0.370 |
| L1 | 0.8 | | 1.20 | 0.031 | | 0.047 |
| L2 | | 0.80 | 1 | | 0.031 | 0.039 |
| V1 | | 10° | | | 10° | |

3 Ordering Information

Table 7. Ordering information

| Order code | Marking | Package | Weight | Base qty | Delivery mode |
|---------------|---------|---------|--------|----------|---------------|
| STPS5H100B | S5H100 | DPAK | 0.30 g | 75 | Tube |
| STPS5H100B-TR | S5H100 | | | 2500 | Tape and reel |
| STPS5H100H | S5H100H | IPAK | 0.40 g | 75 | Tube |

4 Revision history

Table 8. Document revision history

| Date | Revision | Description of Changes |
|-------------|----------|--|
| Jul-2003 | 6B | Last issue. |
| 03-Nov-2005 | 7 | DPAK footprint dimensions updated. |
| 15-Feb-2006 | 8 | ECOPACK statement added. |
| 05-Mar-2007 | 9 | IPAK package added. |
| 01-Aug-2014 | 10 | Updated DPAK package information. |
| 17-Sep-2014 | 11 | Updated Table 2 , title Figure 3 and Figure 11 . |
| 14-Oct-2014 | 12 | Updated DPAK package information. |

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